

Product Data Sheet Type: PR17/25/SE

Group: **HEATSINKS Board Level**

For single mounting

Width: 17 mm Height: 13 mm Length: 25 mm Minimum thermal resistance: 24 K/W TO 220 For device: Device mounted by: Screw Heatsink mounted by: Srew-On

Surface: Black Anodised Material: AlMgSiO,5

- U-extruded especially for semiconductor case TO220 or 2xSOT32(TO126).
- Standard type, ready to be fitted:
- PR 17/15/SE = with 3 mm hole for lying mounting PR 17/25/SE = with M3-thread for lying mounting
- PR 17/35/SE = with M3-thread for lying mounting
- PR 17/35II/SE = with 3,0 mm holes for lying mounting and twist protection
- PR 17/50/SE = with 3,0 mm holes for double mounting SOT32(TO126)
- Also available in meter lengths.
- Other lengths and machining on request.



